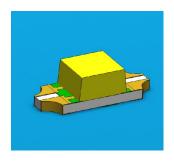


DATASHEET

SMD • B 23-22B/T3S2D-C30/2A



Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Multi-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

Description

- The 23-22B SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.



Device Selection Guide

Code	Chip Materials	Emitted Color	Resin Color	
Т3	InGaN	Pure White	- Yellow Diffused	
S2	AlGalnP	Brilliant Orange		

Absolute Maximum Ratings (Ta=25)

Parameter	Symbol	Code	Rating	Unit	
Reverse Voltage	V _R		5	V	
Famuumd Cummant		Т3	10		
Forward Current	l _F	S2	25	- mA	
eak Forward Current (Duty 1/10 @1KHz)		Т3	100	A	
	I _{FP}	S2	60	- mA	
Power Dissipation		Т3	40		
	Pd	S2	60	- mW	
Operating Temperature	T _{opr}		-40 ~ +85		
Storage Temperature	Tstg		-40 ~ +90		
Electrostatic Dischause	ESD _{HBM}	Т3	150	- \/	
Electrostatic Discharge		S2	2000	- V	
Soldering Temperature	Tsol		Reflow Soldering : 260 Hand Soldering : 350	o for 10 sec. for 3 sec.	



Electro-Optical Characteristics (Ta=25)

Parameter	Symbol	Code	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity		Т3	45.0		112	— mcd	
	lv	S2	9.00		22.5	mcu	
Viewing Angle	2θ _{1/2}			140		deg	
Peak Wavelength	р	S2		611		nm	
Dominant Wavelength	d	S2		605		nm	— I _F =5mA
Spectrum Radiation Bandwidth		S2		17		nm	
Forward Voltage		Т3	2.50	3.10	3.50	V	
	V_{F}	S2	1.55	1.85	2.25		
Reverse Current	I _R	Т3			50	μΑ	V _R =5V
		S2			10		

Note:

Tolerance of Luminous Intensity: ±11%



Bin Range of Luminous Intensity

T3

Bin Code	Min.	Max.	Unit	Condition
Р	45.0	72.0		
Q	72.0	112	mcd	I _F =5mA

Bin Range of Luminous Intensity

S2

Bin Code	Min.	Max.	Unit	Condition
1	9.00	14.5		
2	14.5	22.5	mcd	I _F =5mA

Tolerance of Luminous Intensity: ±11%



Chromaticity Coordinates Specifications for Bin Grading T3

Bin Code	CIE_x	CIE_y	Condition
	0.274	0.226	
	0.274	0.258	_
1	0.294	0.286	_
	0.294	0.254	_
	0.274	0.258	_
0	0.274	0.291	-
2	0.294	0.319	-
	0.294	0.286	_
3	0.294	0.254	- I _F =5mA
	0.294	0.286	_
	0.314	0.315	
	0.314	0.282	
4	0.294	0.286	
	0.294	0.319	
	0.314	0.347	
	0.314	0.315	

Notes:

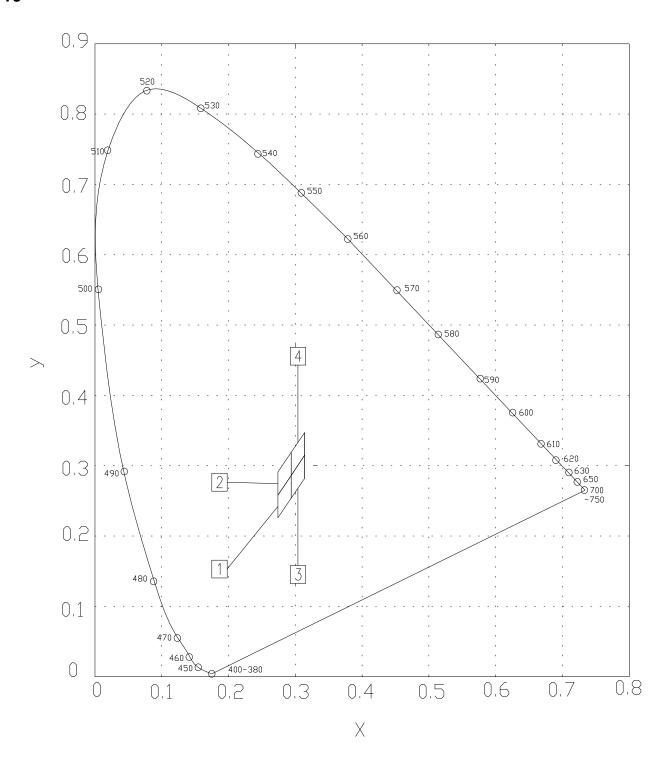
^{1.}The C.I.E. 1931 chromaticity diagram (Tolerance ±0.01).

^{2.} The products are sensitive to static electricity and care must be fully taken when handling products.



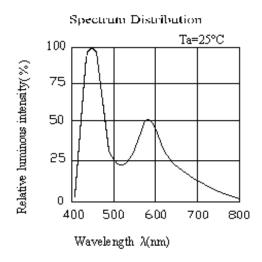
CIE Chromaticity Diagram

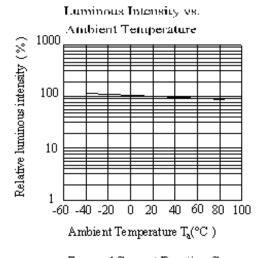
T3

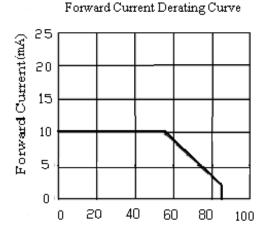


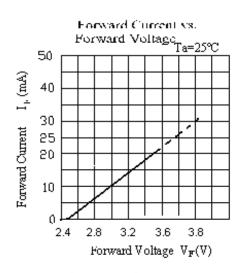


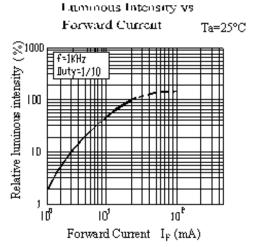
Typical Electro-Optical Characteristics Curves T3

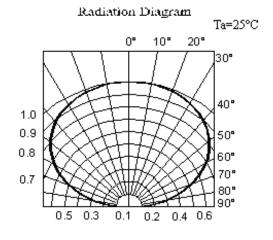






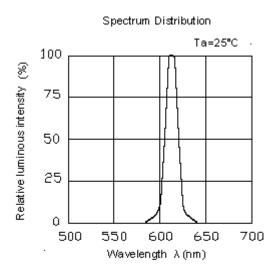


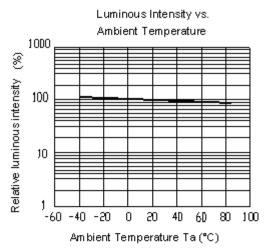


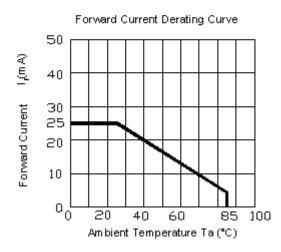


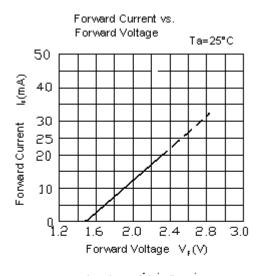


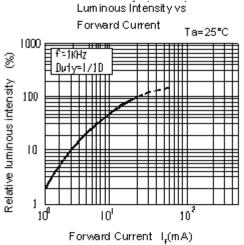
Typical Electro-Optical Characteristics Curves S2

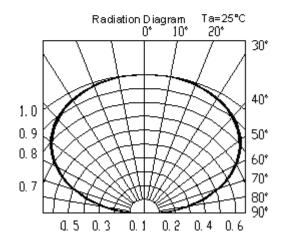






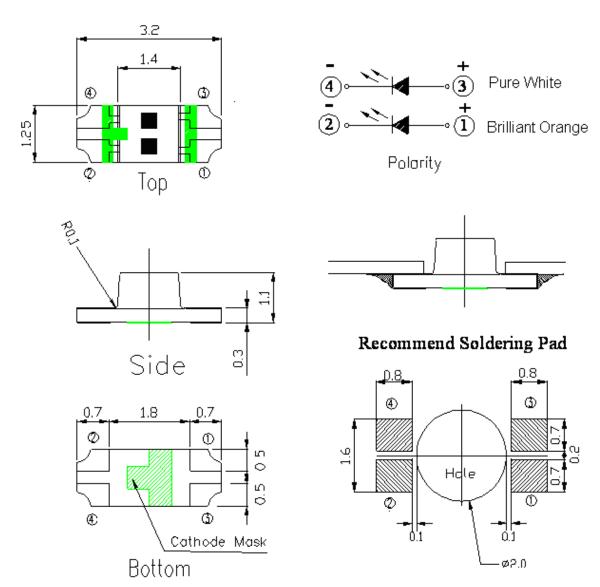








Package Dimension



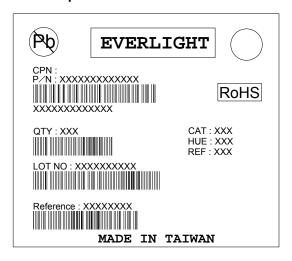
Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

Note: Tolerances unless mentioned ±0.1mm. Unit = mm



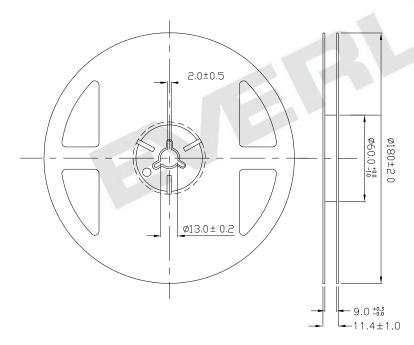
Moisture Resistant Packing Materials

Label Explanation



- · CPN: Customer's Product Number
- P/N: Product Number
- · QTY: Packing Quantity
- · CAT: Luminous Intensity Rank
- HUE: Chromaticity Coordinates & Dom. Wavelength Rank
- REF: Forward Voltage Rank
- · LOT No: Lot Number

Reel Dimensions

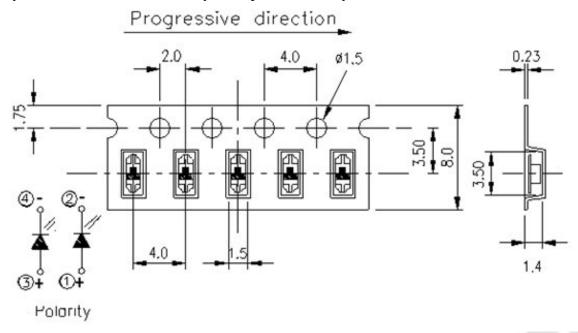


Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

LifecyclePhase:

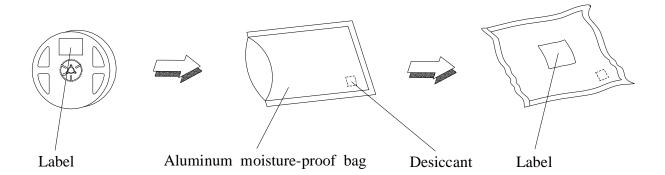
rired Period: Forever

Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging





Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

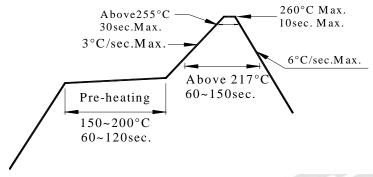
2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30 or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5 for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



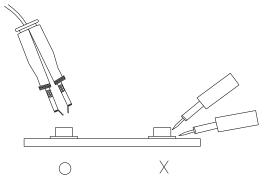
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350 for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



LifecyclePhase:

Rev.2



Application Restrictions

High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.



单击下面可查看定价,库存,交付和生命周期等信息

>>Everlight(亿光)